



Photocoupler

Product Data Sheet

LTV-715F

(M, S, S-TA, S-TA1) series

Spec No.: DS-70-99-0006

Effective Date: 07/28/2016

Revision: C

LITE-ON DCC

RELEASE

BNS-OD-FC001/A4

Photocoupler LTV-715F (M, S, S-TA, S-TA1) series

1. DESCRIPTION

1.1 Features

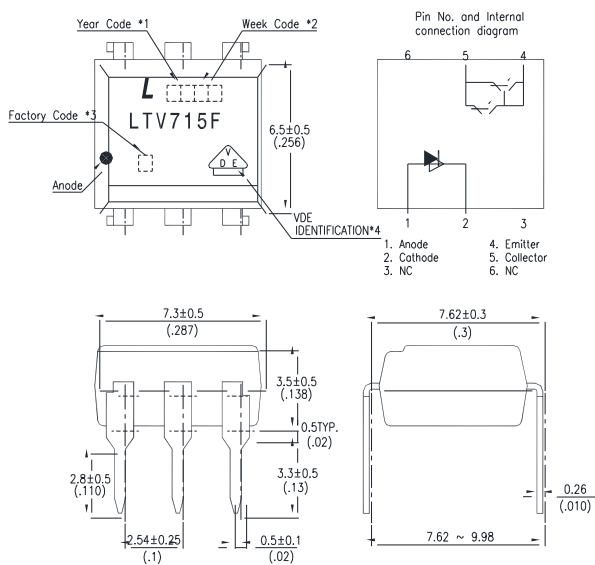
- Current transfer ratio (CTR : MIN. 600% at $I_F = 1\text{mA}$, $V_{CE} = 2\text{V}$)
- High input-output isolation voltage ($V_{ISO}=5,000\text{Vrms}$)
- Dual-in-line package
LTV-715F
- Wide lead spacing package
LTV-715FM
- Surface mounting package
LTV-715FS
- Tape and reel packaging
LTV-715FS-TA, LTV-715FS-TA1
- Safety approval
 - * UL approved (No. E113898)
 - * TUV approved (No. R9653630)
 - * CSA approved (No. CA91533-1)
 - * FIMKO approved (No. 202944)
 - * NEMKO approved (No. P98101737)
 - * DEMKO approved (No. 307925)
 - * SEMKO approved (No. 9833170 / 01)
 - * VDE approved (No. 094722)
- RoHS Compliance
All materials be used in device are followed EU RoHS directive (No.2002/95/EC).
- ESD pass HBM 8000V/MM2000V

- MSL class1

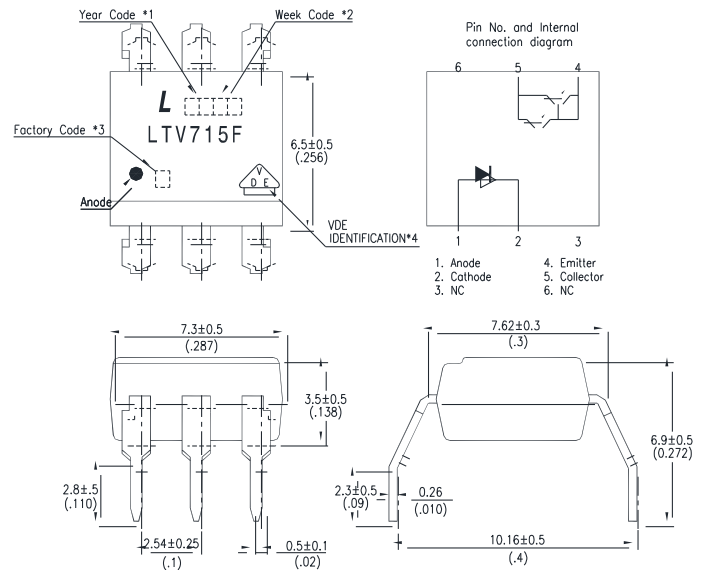
Photocoupler LTV-715F (M, S, S-TA, S-TA1) series

2. PACKAGE DIMENSIONS

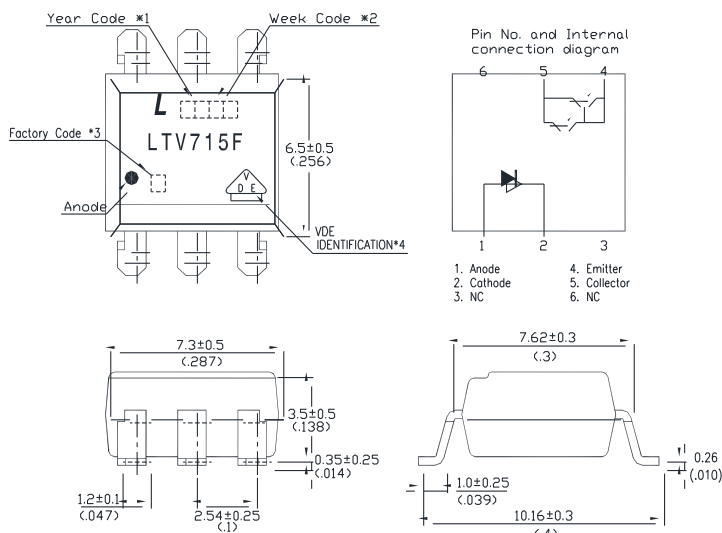
2.1 LTV-715F



2.2 LTV-715FM



2.3 LTV-715FS



Notes :

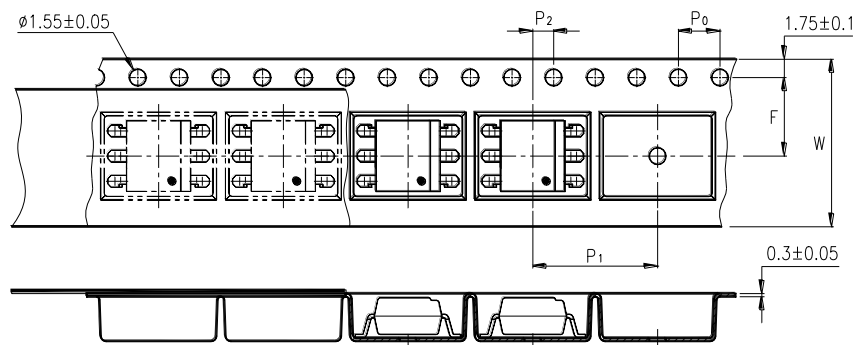
1. Year date code.
2. 2-digit work week.
3. Factory identification mark shall be marked (Y: Thailand, W: China-CZ).
4. For VDE option.

Dimensions in millimeters (inches)

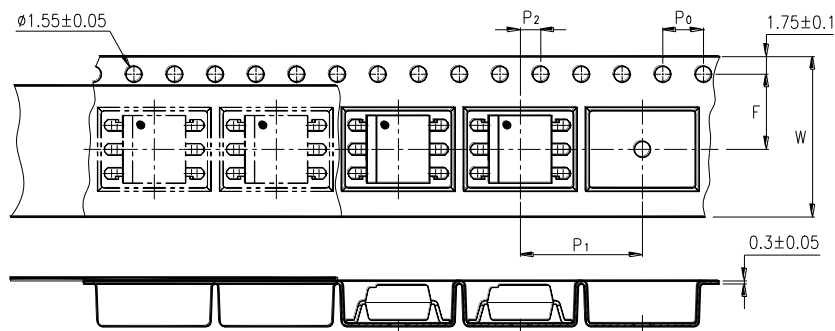
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3. TAPING DIMENSIONS

3.1 LTV-715FS-TA



3.2 LTV-715FS-TA1



Description	Symbol	Dimension in mm (inch)
Tape wide	W	16±0.3 (0.63)
Pitch of sprocket holes	P ₀	4±0.1 (0.15)
Distance of compartment	F	7.5±0.1 (0.295)
	P ₂	2±0.1 (0.079)
Distance of compartment to compartment	P ₁	12±0.1 (0.472)

3.3 Quantities Per Reel

Package Type	TA / TA1
Quantities (pcs)	1000

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4. RATING AND CHARACTERISTICS

4.1 Absolute Maximum Ratings at Ta=25°C

	Parameter	Symbol	Rating	Unit
Input	Forward Current	I_F	50	mA
	Reverse Voltage	V_R	6	V
	Power Dissipation	P	70	mW
	Junction Temperature	T_J	125	°C
Output	Collector - Emitter Voltage	V_{CEO}	35	V
	Emitter - Collector Voltage	V_{ECO}	6	V
	Collector Current	I_C	80	mA
	Collector Power Dissipation	P_C	150	mW
	Total Power Dissipation	P_{tot}	170	mW
1.	Isolation Voltage	V_{iso}	5000	V_{rms}
	Operating Temperature	T_{opr}	-25 ~ +100	°C
	Storage Temperature	T_{stg}	-40 ~ +125	°C
2.	Soldering Temperature	T_{sol}	260	°C

1. AC For 1 Minute, R.H. = 40 ~ 60%

Isolation voltage shall be measured using the following method.

- (1) Short between anode and cathode on the primary side and between collector and emitter on the secondary side.
- (2) The isolation voltage tester with zero-cross circuit shall be used.
- (3) The waveform of applied voltage shall be a sine wave.

2. For 10 Seconds

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4.2 ELECTRICAL OPTICAL CHARACTERISTICS at Ta=25°C

Parameter		Symbol	Min.	Typ.	Max.	Unit	Test Condition
Input	Forward Voltage	V_F	—	1.2	1.4	V	$I_F=10\text{mA}$
	Reverse Current	I_R	—	—	10	μA	$V_R=4\text{V}$
	Terminal Capacitance	C	—	30	250	pF	$V=0, f=1\text{MHz}$
Output	Collector Dark Current	I_{CEO}	—	—	1000	nA	$V_{CE}=10\text{V}, I_{F5}=0$
	Collector-Emitter Breakdown Voltage	BV_{CEO}	35	—	—	V	$I_C=0.1\text{mA}, I_F=0$
	Emitter-Collector Breakdown Voltage	BV_{ECO}	6	—	—	V	$I_E=10\mu\text{A}, I_F=0$
Couple	Collector Current	I_C	6	16	75	mA	$I_F=1\text{mA}, V_{CE}=2\text{V}$
	1. Current Transfer Ratio	CTR	600	1600	7500	%	
	Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	—	—	1.0	V	$I_F=20\text{mA}$ $I_C=5\text{mA}$
	Isolation Resistance	R_{ISO}	5×10^{10}	10^{11}	—	Ω	DC500V, 40 ~ 60%.R.H.
	Floating Capacitance	C_f	—	0.6	1	pF	$V=0, f=1\text{MHz}$
	Cut-Off Frequency	f_c	—	6	—	kHz	$V_{CE}=2\text{V}, I_C=20\text{mA}$ $R_L=100\Omega, -3\text{dB}$
	Response Time (Rise)	t_r	—	60	250	μs	$V_{CE}=2\text{V}, I_C=10\text{mA}$ $R_L=100\Omega$
	Response Time (Fall)	t_f	—	53	250	μs	

$$1. \text{ CTR} = \frac{I_C}{I_F} \times 100\%$$

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5. CHARACTERISTICS CURVES

Fig.1 Forward Current vs.
Ambient Temperature

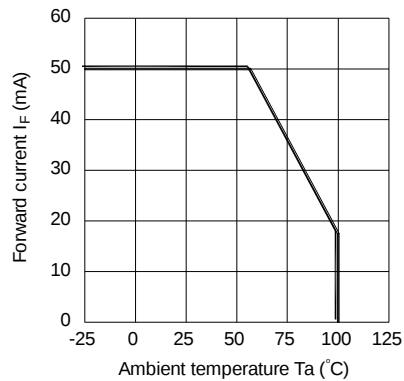


Fig.2 Collector Power Dissipation vs.
Ambient Temperature

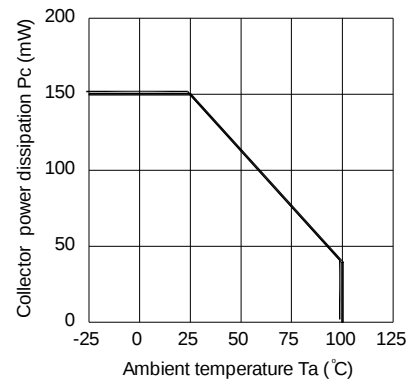


Fig.3 Current Transfer Ratio vs. Forward
Current

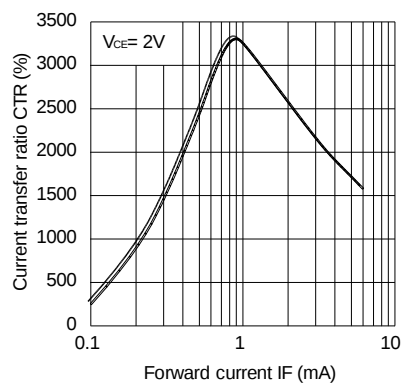


Fig.4 Forward Current vs. Forward
Voltage

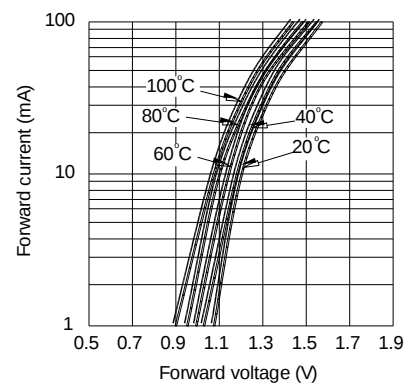


Fig.5 Collector Current vs.
Collector-emitter Voltage

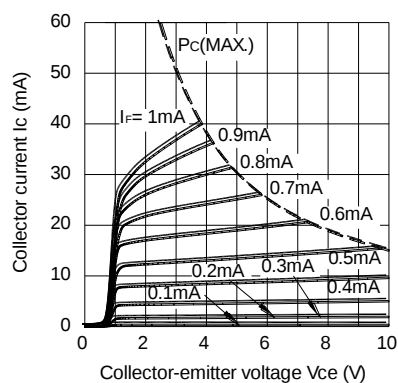
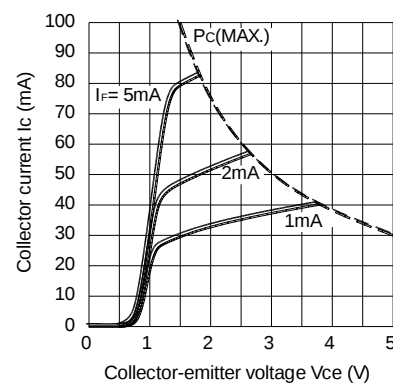


Fig.6 Collector Current vs.
Collector-emitter Voltage



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Fig.7 Relative Current Transfer Ratio vs. Ambient Temperature

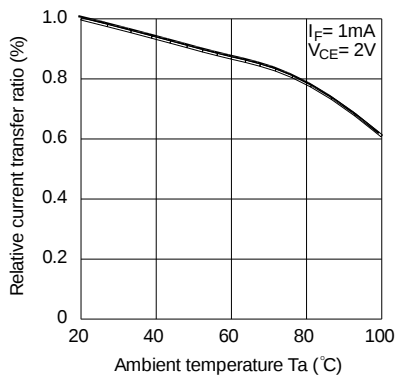


Fig.8 Collector-emitter Saturation Voltage vs. Ambient Temperature

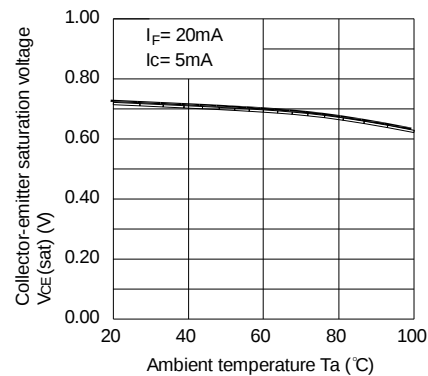


Fig.9 Collector Dark Current vs. Ambient Temperature

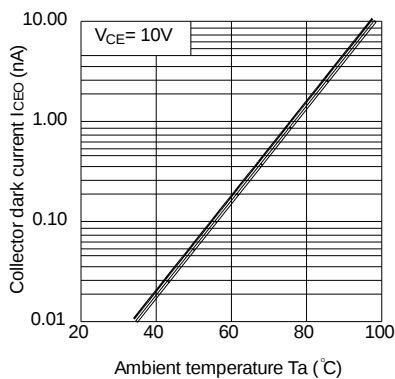


Fig.10 Response Time vs. Load Resistance

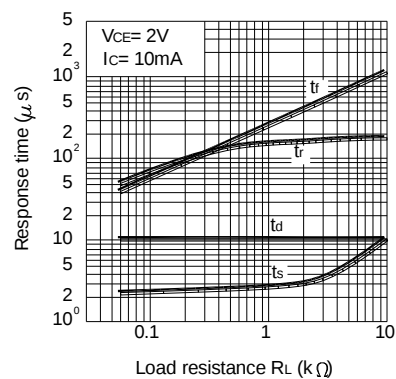
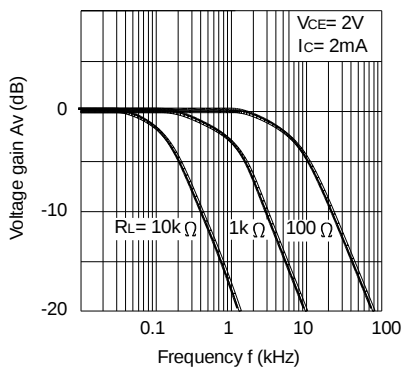
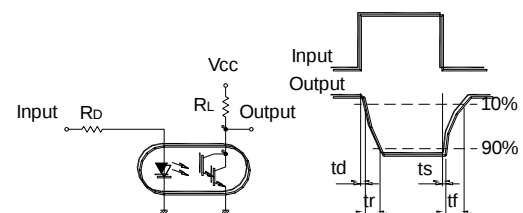


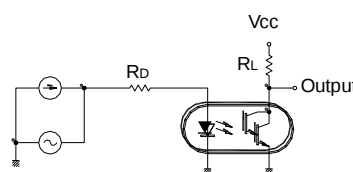
Fig.11 Frequency Response



Test Circuit for Response Time



Test Circuit for Frequency Response



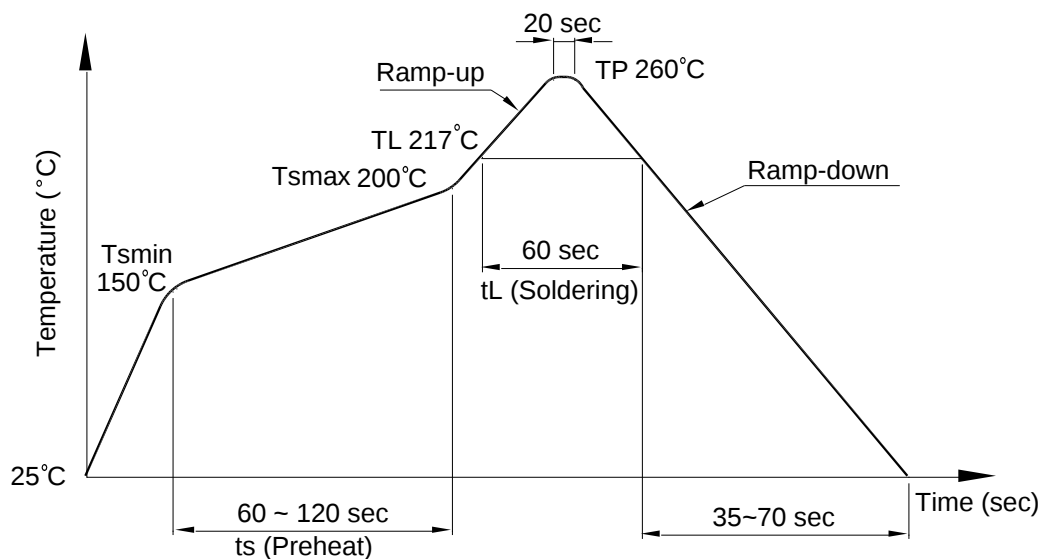
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6. TEMPERATURE PROFILE OF SOLDERING

6.1 IR Reflow soldering (JEDEC-STD-020C compliant)

One time soldering reflow is recommended within the condition of temperature and time profile shown below. Do not solder more than three times.

Profile item	Conditions
Preheat	
- Temperature Min (T_{Smin})	150°C
- Temperature Max (T_{Smax})	200°C
- Time (min to max) (ts)	90±30 sec
Soldering zone	
- Temperature (T_L)	217°C
- Time (t_L)	60 sec
Peak Temperature (T_P)	260°C
Ramp-up rate	3°C / sec max.
Ramp-down rate	3~6°C / sec



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6.2 Wave soldering (JEDEC22A111 compliant)

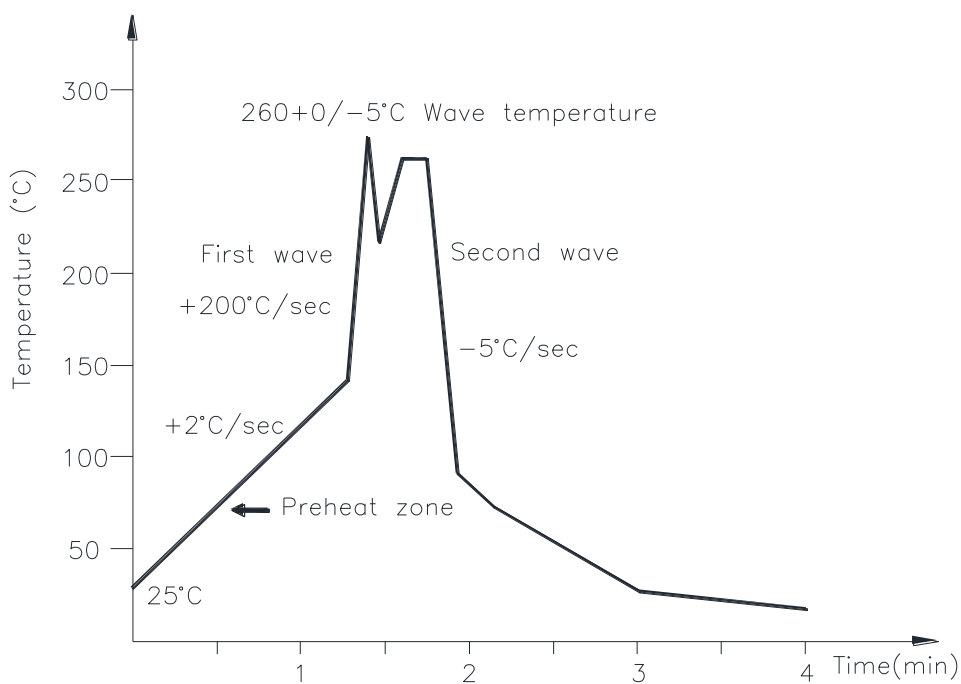
One time soldering is recommended within the condition of temperature.

Temperature: $260 \pm 0/-5^{\circ}\text{C}$

Time: 10 sec.

Preheat temperature: 25 to 140°C

Preheat time: 30 to 80 sec.



6.3 Hand soldering by soldering iron

Allow single lead soldering in every single process. One time soldering is recommended.

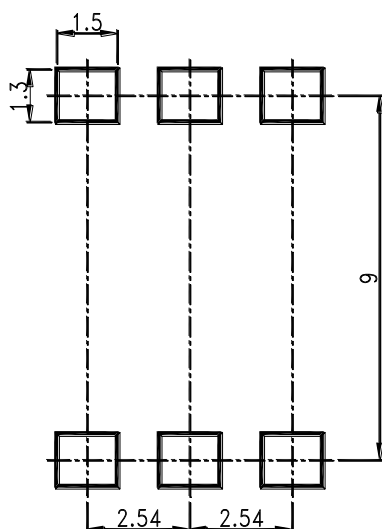
Temperature: $380 \pm 0/-5^{\circ}\text{C}$

Time: 3 sec max.

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7. RRECOMMENDED FOOT PRINT PATTERNS (MOUNT PAD)

Unit: mm



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8. NAMING RULE

LTV-715F(1)-(2)

DEVICE PART NUMBER

- (1) No suffix = Dual-in-Line package
 M = Wide lead spacing package
 S = Surface mounting package

- (2) TAPING TYPE (TA, TA1)
 Please refer to orientation of taping on Page: 3

Example : LTV-715FS-TA1

LTV715F(1)(2)-V

DEVICE PART NUMBER

- (1) No suffix = Dual-in-Line package
 M = Wide lead spacing package
 S = Surface mounting package

- (2) TAPING TYPE (TA, TA1)
 Please refer to orientation of taping on Page: 3

- (3) VDE order option

Example : LTV715FSTA1-V

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9. NOTES

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- The products shown in this publication are designed for the general use in electronic applications such as office automation equipment, communications devices, audio/visual equipment, electrical application and instrumentation.
- For equipment/devices where high reliability or safety is required, such as space applications, nuclear power control equipment, medical equipment, etc, please contact our sales representatives.
- When requiring a device for any "specific" application, please contact our sales in advice.
- If there are any questions about the contents of this publication, please contact us at your convenience.
- The contents described herein are subject to change without prior notice.
- Immerge unit's body in solder paste is not recommended.

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